

4AK20

Silicon N-Channel Power MOS FET Array



Application

High speed power switching

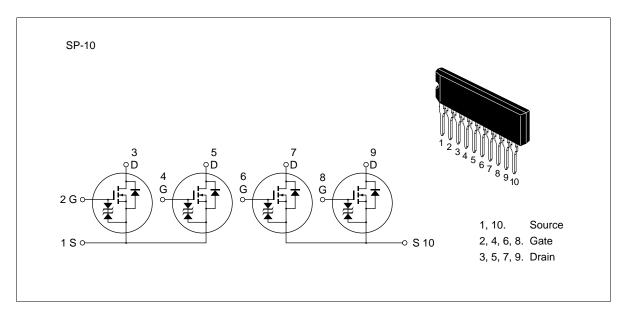
Features

- Low on-resistance $R_{DS(on)}$ 0.25 , V_{GS} = 10 V, I_D = 2.5 A
 - $R_{DS(on)}$ 0.35 , $V_{GS} = 4$ V, I $_{D} = 2.5$ A
- Capable of 4 V gate drive
- Low drive current
- High speed switching
- High density mounting
- Suitable for motor driver, solenoid driver and lamp driver
- Discrete packaged devices of same die: 2SK1300, 2SK1305



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Outline



Absolute Maximum Ratings (Ta = 25°C) (1 Unit)

Symbol	Rating	Unit V	
V _{DSS}	100		
V _{GSS}	±20	V	
I _D	5	А	
L * 1 D(pulse)	20	A	
I _{DR}	5	A	
Pch (Tc = 25°C)*2	28	W	
Pch*2	4	W	
Tch	150	°C	
Tstg	–55 to +150	°C	
	V_{DSS} V_{GSS} I_D $I_{D(pulse)}^{*1}$ I_{DR} $Pch (Tc = 25^{\circ}C)^{*2}$ Pch^{*2} Tch	V 100 VGSS ± 20 I 5 I 20 I 5 I 5 I 5 Pch (Tc = 25° C)*2 28 Pch*2 4 Tch 150	

Notes: 1. $PW \le 10 \ \mu s$, duty cycle $\le 1\%$

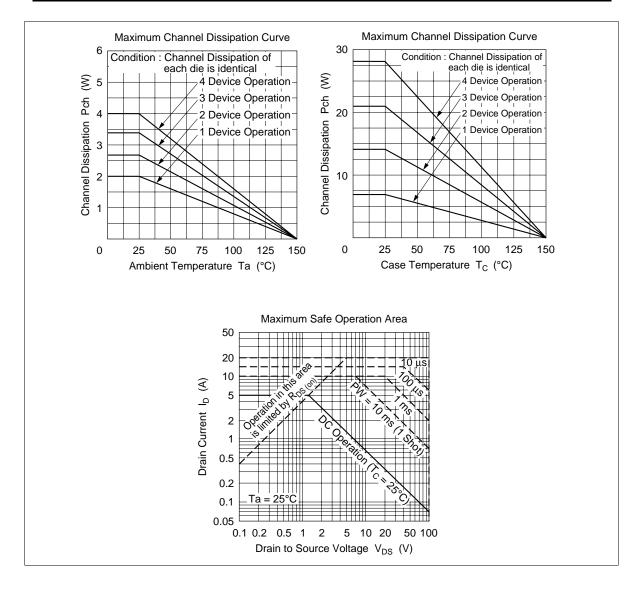
2. 4 devices operation

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{\rm (BR)DSS}$	100	_	_	V	$I_{_{ m D}}$ = 10 mA, $V_{_{ m GS}}$ = 0
Gate to source breakdown voltage	$V_{\rm (BR)GSS}$	±20	_	_	V	$I_{g} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_		±10	μΑ	$V_{GS} = \pm 16 V, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	250	μΑ	$V_{\rm DS} = 80$ V, $V_{\rm GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	_	2.0	V	$I_{\rm D}$ = 1 mA, $V_{\rm DS}$ = 10 V
Static drain to source on state resistance	$R_{\text{DS(on)}}$	_	0.2	0.25	Ω	$I_{D} = 2.5 \text{ A}$ $V_{GS} = 10 \text{ V}^{*1}$
		_	0.25	0.35	Ω	$I_{D} = 2.5 \text{ A}$ $V_{GS} = 4 \text{ V}^{*1}$
Forward transfer admittance	y _{fs}	3.0	5.0	_	S	$I_{D} = 2.5 \text{ A}$ $V_{DS} = 10 \text{ V}^{*1}$
Input capacitance	Ciss	_	525	_	pF	V _{DS} = 10 V
Output capacitance	Coss	_	205	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	60	_	pF	f = 1 MHz
Turn-on delay time	t _{d(on)}	_	5	_	ns	I _D = 2.5 A
Rise time	t,	_	30	_	ns	V _{GS} = 10 V
Turn-off delay time	t _{d(off)}	_	180	_	ns	$R_L = 12 \Omega$
Fall time	t _f	_	65	—	ns	
Body to drain diode forward voltage	V_{DF}	—	1.0	_	V	$I_{F} = 5 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	t _{rr}	—	170	_	ns	$I_{F} = 5 \text{ A}, V_{GS} = 0$ dIF/dt = 50 A/µs
Note: 1. Pulse Test						

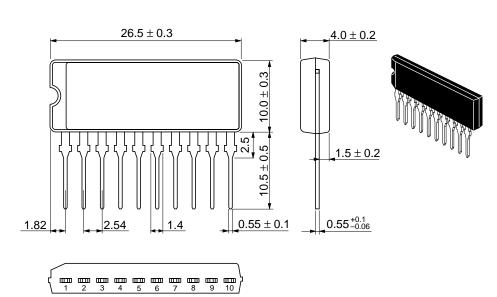
Electrical Characteristics (Ta = 25°C) (1 Unit)

See characteristic curves of 2SK1300

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Unit: mm

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